

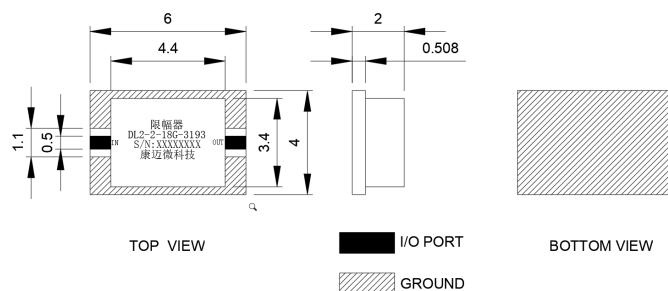
Main specifications

Parameters	Min	Typical	Max	Units
Frequency	2	~	18	GHz
Clipping level			18	dBm
IL			1.5	dB
VSWR			1.7	

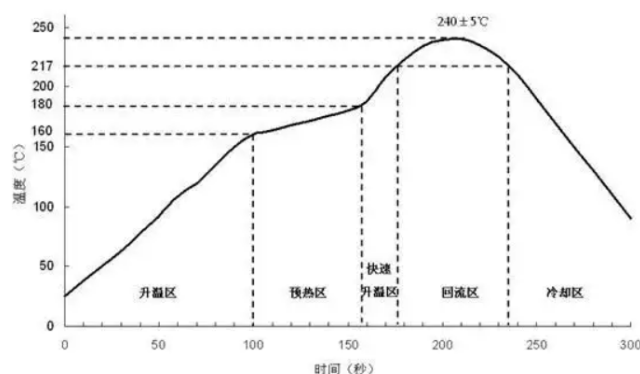
Other parameters

Power Capacity	3W Design assurance
Impedance	50Ω
Connector	Microstrip pad
Operation Temp.	-40~+70°C Design assurance
Storage Temp.	-55~+85°C Design assurance

Configuration(mm)



Schematic diagram of reflow soldering



Note

- 1, Pay attention to the direction of input and output, reverse connection may cause the product to burn out.
- 2、本产品支持220°C回流焊。
- 3、产品内部无隔直电容，请根据实际使用情况，在外部添加隔直电容。